

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)	Power Dissipation @ $T_C = 25^\circ\text{C}$	θ_{JC} $^\circ\text{C/W}$	θ_{JA} $^\circ\text{C/W}$	I_{DR}^*	I_{DRM}
VN3515L (TO-92)	150mA	600mA	1W	125	170	150mA	600mA
VN4012L (TO-92)	160mA	650mA	1W	125	170	160mA	650mA

* I_D (continuous) is limited by max rated T_j .

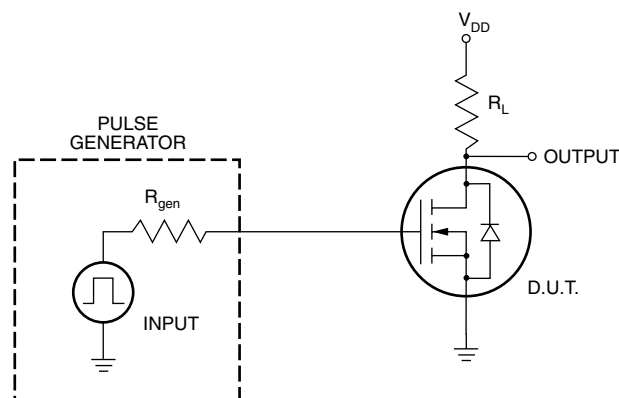
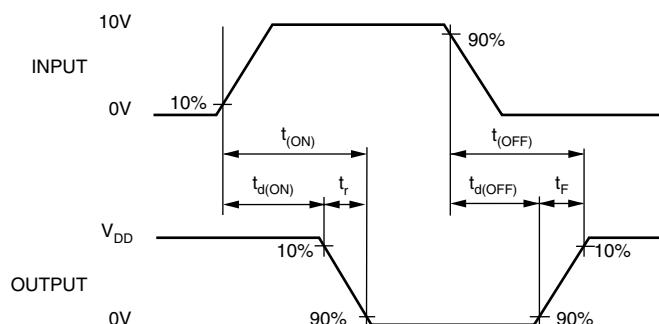
Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	VN3515 350			V	$V_{GS} = 0V, I_D = 100\mu A$
		VN4012 400				
$V_{GS(th)}$	Gate Threshold Voltage	0.6		1.8	V	$V_{GS} = V_{DS}, I_D = 1mA$
I_{GSS}	Gate Body Leakage			10	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
I_{DSS}	Zero Gate Voltage Drain Current			1	μA	$V_{GS} = 0V, V_{DS} = 0.8 \text{ Max Rating}$
				100		$V_{GS} = 0V, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current	0.15	0.3		A	$V_{DS} = 10V, V_{GS} = 4.5V$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance	VN3515	9.5	15	Ω	$V_{GS} = 4.5V, I_D = 100mA$
			17	35		$V_{GS} = 4.5V, I_D = 100mA, T_A = 125^\circ\text{C}$
		VN4012	9.5	12		$V_{GS} = 4.5V, I_D = 100mA$
			17	30		$V_{GS} = 4.5V, I_D = 100mA, T_A = 125^\circ\text{C}$
G_{FS}	Forward Transconductance	125	350		mS	$V_{DS} = 15V, I_D = 100mA$
C_{ISS}	Input Capacitance			110	pF	$V_{DS} = 25V, V_{GS} = 0V$ $f = 1MHz$
C_{OSS}	Common Source Output Capacitance			30		
C_{RSS}	Reverse Transfer Capacitance			10		
$t_{d(ON)}$	Turn-ON Delay Time			20	ns	$V_{DD} = 25V$ $I_D = 100mA$ $R_{GEN} = 25\Omega$
t_r	Rise Time			20		
$t_{d(OFF)}$	Turn-OFF Delay Time			65		
t_f	Fall Time			65		
V_{SD}	Diode Forward Voltage Drop			1.2	V	$V_{GS} = 0V, I_{SD} = 160mA$

Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.
3. See TN2540 data sheet for characteristic curves.

Switching Waveforms and Test Circuit



11/12/01